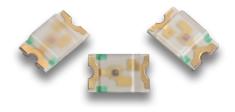
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2.0 x 1.25 mm SMD Chip LED Lamp



DESCRIPTIONS

- The Super Bright Orange device is made with AIGaInP (on GaAs substrate) light emitting diode chip
- · Electrostatic discharge and power surge could damage the LEDs
- · It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- · All devices, equipments and machineries must be electrically grounded

FEATURES

- 2.0 x 1.25 mm SMD LED, 0.5 mm max. thickness
- Low power consumption
- · Wide viewing angle
- · Ideal for backlight and indicator
- Package: 2000 pcs / reel
- Moisture sensitivity level: 3
- · Halogen-free
- RoHS compliant

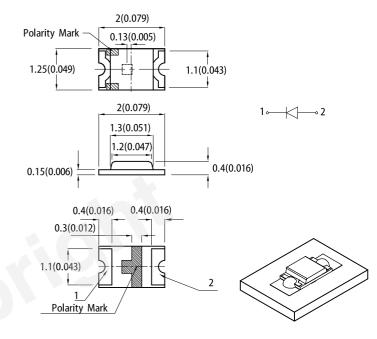
APPLICATIONS

- Backlight
- · Status indicator
- · Home and smart appliances
- Wearable and portable devices
- · Healthcare applications

ATTENTION

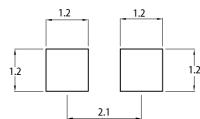
Observe precautions for handling electrostatic discharge sensitive devices

PACKAGE DIMENSIONS



RECOMMENDED SOLDERING PATTERN

(units : mm; tolerance : ± 0.1)



- All dimensions are in millimeters (inches).
 Tolerance is ±0.1(0.004") unless otherwise noted.
- 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

The device has a single mounting surface. The device must be mounted according to the specifications.

SELECTION GUIDE

Part Number	Emitting Color (Material)	Lens Type	lv (mcd) @ 20mA ^[2]		Viewing Angle ^[1]	
			Min.	Тур.	201/2	
KPHCM-2012SECK	Super Bright Orange (AlGaInP)	Water Clear	120	250	140°	
			*80	*180	140	

Notes

Holes.
 Holes.

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ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Deventer	Cumhal	Ensitting Oslan	Value		Unit
Parameter	Symbol	Emitting Color	Typ. Max.		
Wavelength at Peak Emission I _F = 20mA	λ_{peak}	Super Bright Orange	610	-	nm
Dominant Wavelength I _F = 20mA	λ_{dom} ^[1]	Super Bright Orange	605	-	nm
Spectral Bandwidth at 50% Φ REL MAX I _F = 20mA	Δλ	Super Bright Orange	29	-	nm
Capacitance	С	Super Bright Orange	15	-	pF
Forward Voltage I _F = 20mA	V _F ^[2]	Super Bright Orange	2.1	2.5	V
Reverse Current ($V_R = 5V$)	I _R	Super Bright Orange	-	10	μΑ
Temperature Coefficient of λ_{peak} I_F = 20mA, -10°C $\leq T \leq 85^\circ C$	TC _{λpeak}	Super Bright Orange	0.13	-	nm/°C
Temperature Coefficient of λ_{dom} I_F = 20mA, -10°C $\leq T \leq 85^\circ C$	TC _{λdom}	Super Bright Orange	0.06	-	nm/°C
Temperature Coefficient of V_F I_F = 20mA, -10°C \leq T \leq 85°C	TCv	Super Bright Orange	-1.9	-	mV/°C

Notes:

The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd : ±1nm.)
 Forward voltage: ±0.1V.
 Wavelength value is traceable to CIE127-2007 standards.
 Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

ABSOLUTE MAXIMUM RATINGS at T_A=25°C

Parameter	Symbol	Value	Unit
Power Dissipation	P _D	75	mW
Reverse Voltage	V _R	5	V
Junction Temperature	Tj	115	°C
Operating Temperature	T _{op}	-40 to +85	°C
Storage Temperature	T _{stg}	-40 to +85	°C
DC Forward Current	IF	30	mA
Peak Forward Current	I _{FM} ^[1]	195	mA
Electrostatic Discharge Threshold (HBM)	-	3000	V
Thermal Resistance (Junction / Ambient)	R _{th JA} ^[2]	490	°C/W
Thermal Resistance (Junction / Solder point)	R _{th JS} ^[2]	340	°C/W

Notes: 1. 1/10 Duty Cycle, 0.1ms Pulse Width. 2. R_{In, Ja}, R_{In, JS} Results from mounting on PC board FR4 (pad size ≥ 16 mm² per pad). 3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

TECHNICAL DATA

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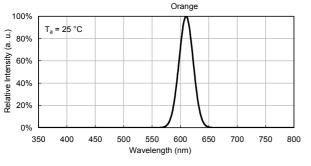
20

10

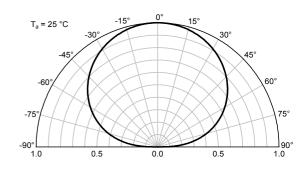
0

Forward current (mA)

RELATIVE INTENSITY vs. WAVELENGTH

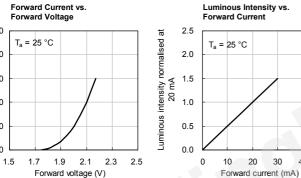


SPATIAL DISTRIBUTION



SUPER BRIGHT ORANGE

50



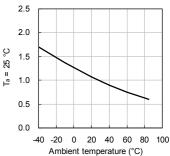
Luminous Intensity vs Forward Current Forward Current Derating Curve 50 40

30 40

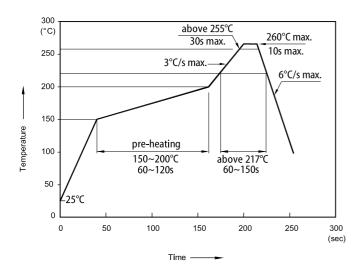
forward current (mA) 30 20 Permissible 1 10 0 -40 -20 0 20 40 60 80 100

Luminous Intensity vs. Ambient Temperature

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REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS

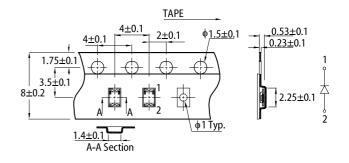


Notes

- Notes: 1. Don't cause stress to the LEDs while it is exposed to high temperature. 2. The maximum number of reflow soldering passes is 2 times. 3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

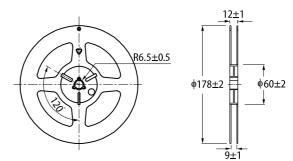
TAPE SPECIFICATIONS (units : mm)

Ambient temperature (°C)



Luminous intensity normalised at

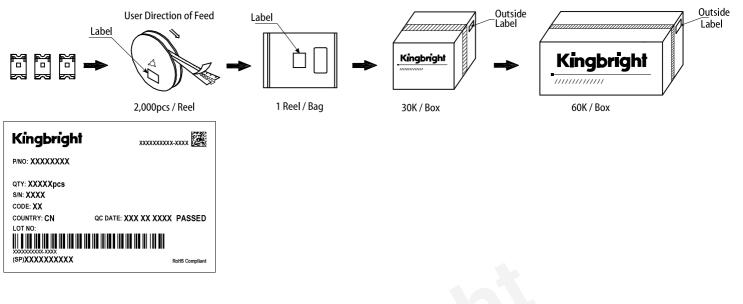
REEL DIMENSION (units : mm)



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PRECAUTIONARY NOTES

- 1. 2.
- The information included in this document reflects representative usage scenarios and is intended for technical reference only. The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to The part datasheet for the updated specifications. When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If
- 3.
- The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance. The contents and information of this document may not be reproduced or re-transmitted without permission by Kingbright. 4.
- 5.
- 6. All design applications should refer to Kingbright application notes available at https://www.King aht cor